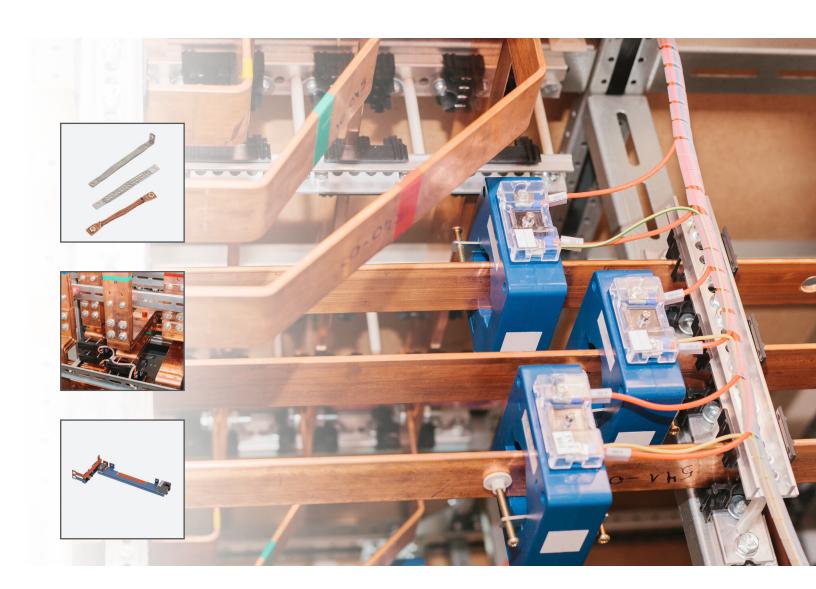
MOLEX DUSBAR SOLUTIONS

Power solutions made simple.







Busbars are the backbone of power distribution. Molex applies its decades of Busbar experience to partner with customers, providing feedback on their designs, recommending solutions, prototyping and more. By working so closely with customers, we strive for the following goals.

- To enhance the performance of our customers' end products with reliable busbar solutions.
- To streamline manufacturing processes and offer cost savings through suggested design improvements.
- To shorten our customers' product development by providing front end design support.
- To provide consumption flexibility with a global manufacturing footprint.

Manufacturing Capabilities

Flexible Grounding Jumpers

Custom lengths

Flat braid

Custom ends

Stocking packages are available through distribution

Flexible Busbars

Round and flat braid versions

Insulated and uninsulated versions

Stacked braid versions

Flex/rigid combined solutions

Molex connector solutions

Rigid Busbars

Capabilities

Swaging of rod

Edge bend and complex forming

Tin, Nickel and Silver plating

Powder coat insulation

Brazing and welding

Value Add

Molex connector solutions

PEM insertion and attachment

Kitting

Laminated Busbars

Alternating layers of conductors and insulation

Mylar, Nomex, Rigid Plastic, FR4

Space Savings

Ease of assembly in customer applications

Features

Molex connector solutions

Improved heat dissipation

Low characteristic impedance

Powder coat solutions

Tin, Nickel and Silver plating









Coeur CST High-Current

Interconnect System

Moving power from point A to B is crucial in today's electrically run world. Customers are looking for innovative ways to connect busbars that offer different methods of attachment to busbars, multiple form factors, and solutions to tolerance concerns. Molex has developed the Coeur CST Interconnect System. This system has form factors of 3.4mm, 6.00mm, and 8.00mm to cover a wide range of amperage needs ranging from 30.0A up to 200A and offers press-fit, weld, and screw attach methods to the busbar for options depending on busbar thickness or space constraints. The system also offers a unique float feature providing up to 1.0mm of float to mitigate pin to socket axial misalignment when mating busbar-to-busbar or busbar-to-PCB. The Coeur CST High-Current Connector can be used in all your busbar design solutions.

Capable of 30.0 to above 200.0A current rating

Offers a scalable design to meet a wide range of high-current applications

Multiple contact beams

Provide optimized electrical performance

Unique socket float feature provides an industry leading 1.0mm of float off the center position

No added deflection on contacts

Low mating forces

Attach methods to busbar PCBs and wire include press-fit, SMT, screw, crimp and weld

Provides design flexibility for a range of high-current applications

One common contact design in all CST sockets regardless of form factor sizes

Provides a low profile height solution across entire current range

Wire to Busbar solutions

Touch-safe available

10 AWG thru I/O AWG crimp range

Positive latching

Vertical male headers screw attached to busbar

600V rating in configuration

Applications

Data Center Solutions

Circuit Breakers
Data Storage
Instrumentation
PDU
Servers
UPS/battery storage

Industrial

Power Supplies

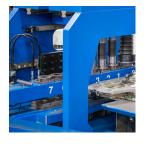
Telecommunications/Networking

Servers Storage Switches





Production Capabilities





















Busbar Machine Process Definitions

Waterjet

High-pressure water mixed with an abrasive to cut hard materials into complex shapes. Best for lowvolume and prototype jobs.

CNC Mills

Computerized program that operates a rotating cylindrical cutting tool that can move in multiple axes to achieve the desired shape. Can be linked with CAD models to program the cut path.

Turret-style punching

Automated metal sheet fabrication using a rotation of many tools to cut complex shapes up to 0.25" thick.

Semi-Automatic production of bar stock material

Cutting, forming, and edge bending of bar stock. Saves on material by not nesting on a sheet and producing scrap.

Stamping and forming operations

Coil and strip processing in custom die sets to achieve high-speed production with extreme accuracy.

Lamination

Use of heat and pressure to insulate one or multiple busbars in an adhesive-lined dielectric. Offers improved thermal and electrical performance and improves ease of assembly when mounting in the system.

Hi-Pot

Hi-Pot test is a nondestructive test that verifies the adequacy of the busbar insulation. The standard test voltage is 2X (operating voltage) +1000V.

Brazing

Two or more metal items are joined together by melting and flowing a filler metal into the joint. Used in higher temperature applications than soldering.

PEM insertion and assembly operations

Press-fit insertion of self-clinching threaded and unthreaded studs and nuts.

Solder dip

Components are dipped in a molten solder bath and bond together upon cooling.

Heat shrink value add

Use of heat to shrink and secure electrical insulation to a conductor.

Wire braid assembly

Flexible power distribution component that eliminates problems caused by vibration in a system.

Get customized insights at: **molex.com**

